

## 3-Pin Microcontroller Reset Monitors

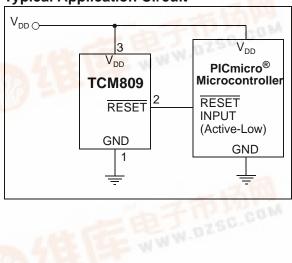
### **Features**

- Precision V<sub>DD</sub> Monitor for 2.5V, 3.0V, 3.3V, 5.0V
   Nominal System Voltage Supplies
- 140 msec Minimum RESET Time Out Period
- RESET Output to V<sub>DD</sub> = 1.0V (TCM809)
- Low Supply Current, 9 μA (typ.)
- V<sub>DD</sub> Transient Immunity
- Small 3-Pin SC-70 and SOT-23B Packages
- No External Components
- Push-Pull RESET Output
- · Temperature Range:
  - Industrial, SC-70 (E): -40°C to +85°C
  - Extended, SOT-23, SC-70 (V): -40°C to +125°C

## **Applications**

- Computers
- Embedded Systems
- Battery-Powered Equipment
- Critical Microcontroller Power Supply Monitoring
- Automotive

## **Typical Application Circuit**



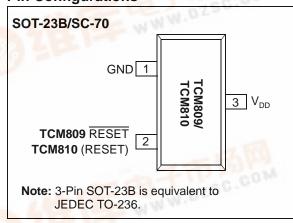
### **General Description**

The TCM809 and TCM810 are cost-effective system supervisor circuits designed to monitor  $V_{DD}$  in digital systems and provide a reset signal to the host processor, when necessary. No external components are required.

The RESET output is typically driven active within 65 µsec of  $V_{DD}$  falling through the reset voltage threshold. RESET is maintained active for a minimum of 140 msec after  $V_{DD}$  rises above the reset threshold. The TCM810 has an active-high RESET output, while the TCM809 has an active-low RESET output. The output of the TCM809/TCM810 is valid down to  $V_{DD} = 1V$ . Both devices are available in 3-Pin SC-70 and SOT-23B packages.

The TCM809/TCM810 is optimized to reject fast transient glitches on the  $V_{DD}$  line. A low supply current of 9  $\mu$ A (typ.,  $V_{DD}$  = 3.3V) make these devices suitable for battery-powered applications.

### **Pin Configurations**





# 1.0 ELECTRICAL CHARACTERISTICS

## **Absolute Maximum Ratings†**

Supply Voltage (V <sub>DD</sub> to GND)6.0V
RESET, RESET – 0.3V to (V <sub>DD</sub> +0.3V)
Input Current, V <sub>DD</sub> 20 mA
Output Current, RESET, RESET20 mA
dV/dt (V <sub>DD</sub> )100V/μsec
Operating Temperature Range 40°C to +125°C
Power Dissipation ( $T_A = 70^{\circ}C$ ):
3-Pin SOT-23B (derate 4 mW/°C above +70°C)320 mW
3-Pin SC-70 (derate 2.17 mW/°C above +70°C)174 mW
Storage Temperature Range – 65°C to +150°C
Maximum Junction Temperature, T <sub>J</sub> 150°C

<sup>†</sup> Notice: Stresses above those listed under "Maximum ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at those or any other conditions above those indicated in the operational listings of this specification is not implied. Exposure to maximum rating conditions for extended periods may affect device reliability.

### **PIN FUNCTION TABLE**

NAME	FUNCTION
GND	Ground.
RESET (TCM809)	RESET push-pull output remains low while $V_{DD}$ is below the reset voltage threshold and for 240 msec (140 msec min.) after $V_{DD}$ rises above reset threshold.
RESET (TCM810)	RESET push-pull output remains high while V <sub>DD</sub> is below the reset voltage threshold and for 240 msec (140 msec min.) after V <sub>DD</sub> rises above reset threshold.
$V_{DD}$	Supply voltage (+2.5V, +3.0V, +3.3V, +5.0V).

## **ELECTRICAL CHARACTERISTICS**

 $V_{DD}$  = Full Range,  $T_A$  = Operating Temperature Range, unless otherwise noted. Typical values are at  $T_A$  = +25°C,  $V_{DD}$  = 5V for L/M/J, 3.3V for T/S, 3.0V for R and 2.5V for Z (**Note 1**).

$V_{DD} = 5V$ for L/M/J, 3.3V for 1/S, 3.0V for R and 2.5V for Z ( <b>Note 1</b> ).								
Parameter	Sym	Min	Тур	Max	Units	Test Conditions		
V <sub>DD</sub> Range		1.0	_	5.5	V	$T_A = 0$ °C to +70°C		
		1.2	_	5.5		$T_A = -40$ °C to +125°C		
Supply Current	$I_{CC}$	_	12	30	μΑ	<b>TCM8xx</b> L/M/J: V <sub>DD</sub> < 5.5V		
			9	25		<b>TCM8xx</b> R/S/T/Z: V <sub>DD</sub> < 3.6V		
Reset Threshold (Note 2)	$V_{TH}$	4.56	4.63	4.70	V	TCM8xxL: $T_A = +25^{\circ}C$		
		4.50		4.75		$T_A = -40^{\circ}\text{C to } +125^{\circ}\text{C}$		
		4.31	4.38	4.45	V	TCM8xxM: $T_A = +25^{\circ}C$		
		4.25	-	4.50	V	$T_A = -40^{\circ}C \text{ to } +125^{\circ}C$		
		3.93	4.00	4.06	V	<b>TCM809</b> J: $T_A = +25^{\circ}C$		
		3.89	_	4.10	V	$T_A = -40^{\circ}C \text{ to } +125^{\circ}C$		
		3.04	3.08	3.11	V	TCM8xxT: $T_A = +25$ °C		
		3.00	_	3.15	V	$T_A = -40^{\circ}C \text{ to } +125^{\circ}C$		
		2.89	2.93	2.96	V	TCM8xxS: $T_A = +25^{\circ}C$		
		2.85	-	3.00	V	$T_A = -40^{\circ}C \text{ to } +125^{\circ}C$		
		2.59	2.63	2.66	V	<b>TCM8xx</b> R: $T_A = +25^{\circ}C$		
		2.55		2.70	V	$T_A = -40^{\circ}\text{C to } +125^{\circ}\text{C}$		
		2.28	2.32	2.35	V	TCM8xxZ: $T_A = +25^{\circ}C$		
		2.25	_	2.38	V	$T_A = -40^{\circ}C \text{ to } +125^{\circ}C$		
Reset Threshold Tempco			30		ppm/°C			
V <sub>DD</sub> to Reset Delay,			65		µsec	$V_{DD} = V_{TH}$ to $(V_{TH} - 100 \text{ mV})$ (Note 2)		
Reset Active Time Out Period	_	140	320	560	msec			

- Note 1: Production testing done at  $T_A = +25$ °C, overtemperature limits ensured by QC screen.
  - 2: RESET output for TCM809, RESET output for TCM810.

## **ELECTRICAL CHARACTERISTICS (CONTINUED)**

 $V_{DD}$  = Full Range,  $T_A$  = Operating Temperature Range, unless otherwise noted. Typical values are at  $T_A$  = +25°C,  $V_{DD}$  = 5V for L/M/J, 3.3V for T/S, 3.0V for R and 2.5V for Z (**Note 1**).

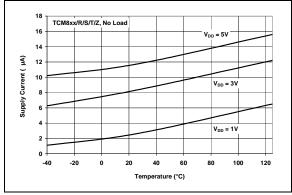
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Parameter	Sym	Min	Тур	Max	Units	Test Conditions				
RESET Output Voltage	V <sub>OL</sub>	_	_	0.3	V	<b>TCM809</b> R/S/T/Z: $V_{DD} = V_{TH} \text{ min, } I_{SINK} = 1.2 \text{ mA}$				
Low ( <b>TCM809</b> )		_	_	0.4		<b>TCM809</b> L/M/J: $V_{DD} = V_{TH} \text{ min, } I_{SINK} = 3.2 \text{ mA}$				
		_	l	0.3		V <sub>DD</sub> > 1.0V, I <sub>SINK</sub> = 50 μA				
RESET Output Voltage	V <sub>OH</sub>	0.8 V <sub>DD</sub>		_	V	TCM809R/S/T/Z: $V_{DD} > V_{TH}$ max, $I_{SOURCE} = 500 \mu A$				
High (TCM809)		V <sub>DD</sub> – 1.5		_		<b>TCM809</b> L/M/J: $V_{DD} > V_{TH}$ max, $I_{SOURCE} = 800 \mu A$				
RESET Output Voltage	V <sub>OL</sub>	_		0.3	V	TCM810R/S/T/Z: $V_{DD} = V_{TH} \text{ max}$ , $I_{SINK} = 1.2 \text{ mA}$				
Low ( <b>TCM810</b> )		_		0.4		<b>TCM810</b> L/M: $V_{DD} = V_{TH} \text{ max}$ , $I_{SINK} = 3.2 \text{ mA}$				
RESET Output Voltage High ( <b>TCM810</b> )	V <sub>OH</sub>	0.8 V <sub>DD</sub>	_	_	V	$1.8 < V_{DD} < V_{TH} min, I_{SOURCE} = 150 \mu A$				

Note 1: Production testing done at  $T_A = +25$ °C, overtemperature limits ensured by QC screen.

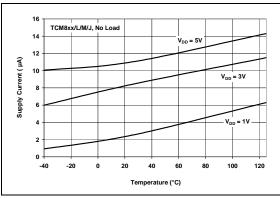
2: RESET output for TCM809, RESET output for TCM810.

## 2.0 TYPICAL PERFORMANCE CHARACTERISTICS

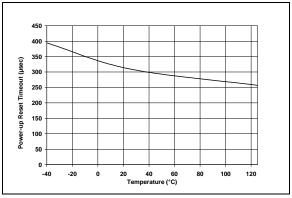
**Note:** The graphs and tables provided following this note are a statistical summary based on a limited number of samples and are provided for informational purposes only. The performance characteristics listed herein are not tested or guaranteed. In some graphs or tables, the data presented may be outside the specified operating range (e.g., outside specified power supply range) and therefore outside the warranted range.



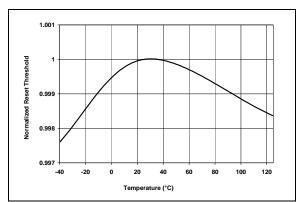
**FIGURE 2-1:** Supply Current vs. Temperature.



**FIGURE 2-2:** Supply Current vs. Temperature.



**FIGURE 2-3:** Power-up Reset Time Out vs. Temperature.



**FIGURE 2-4:** Normalized Reset Threshold vs. Temperature.

### 3.0 APPLICATIONS INFORMATION

## 3.1 V<sub>DD</sub> Transient Rejection

The TCM809/TCM810 provides accurate  $V_{DD}$  monitoring and reset timing during power-up, power-down and brown-out/sag conditions. These devices also reject negative-going transients (glitches) on the power supply line. Figure 3-1 shows the maximum transient duration vs. maximum negative excursion (overdrive) for glitch rejection. Any combination of duration and overdrive that lies under the curve will not generate a reset signal.

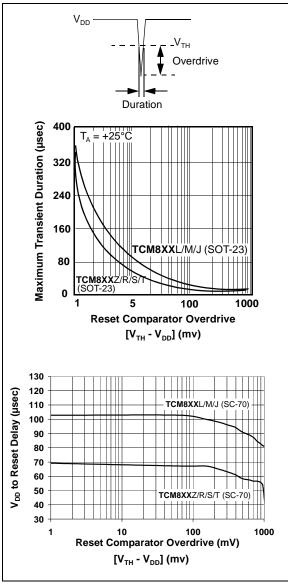
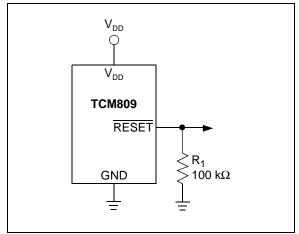


FIGURE 3-1: Maximum Transient
Duration vs. Overdrive for Glitch Rejection at +25°C.

Combinations above the curve are detected as a brown-out or power-down condition. Transient immunity can be improved by adding a capacitor in close proximity to the  $V_{DD}$  pin of the TCM809/TCM810.

# 3.2 RESET Signal Integrity During Power-Down

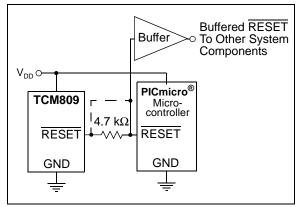
The TCM809  $\overline{\text{RESET}}$  output is valid to  $V_{DD}=1.0V$ . Below this voltage the output becomes an "open circuit" and does not sink current. This means CMOS logic inputs to the microcontroller will be floating at an undetermined voltage. Most digital systems are completely shut down well above this voltage. However, in situations where  $\overline{\text{RESET}}$  must be maintained valid to  $V_{DD}=0V$ , a pull-down resistor must be connected from  $\overline{\text{RESET}}$  to ground to discharge stray capacitances and hold the output low (Figure 3-2). This resistor value, though not critical, should be chosen such that it does not appreciably load  $\overline{\text{RESET}}$  under normal operation (100 k $\Omega$  will be suitable for most applications). Similarly, a pull-up resistor to  $V_{DD}$  is required for the TCM810 to ensure a valid high  $\overline{\text{RESET}}$  for  $V_{DD}$  below 1.0V.



**FIGURE 3-2:** The addition of  $R_1$  at the <u>RESET</u> output of the TCM809 ensures that the RESET output is valid to  $V_{DD} = 0V$ .

# 3.3 Controllers and Processors With Bidirectional I/O Pins

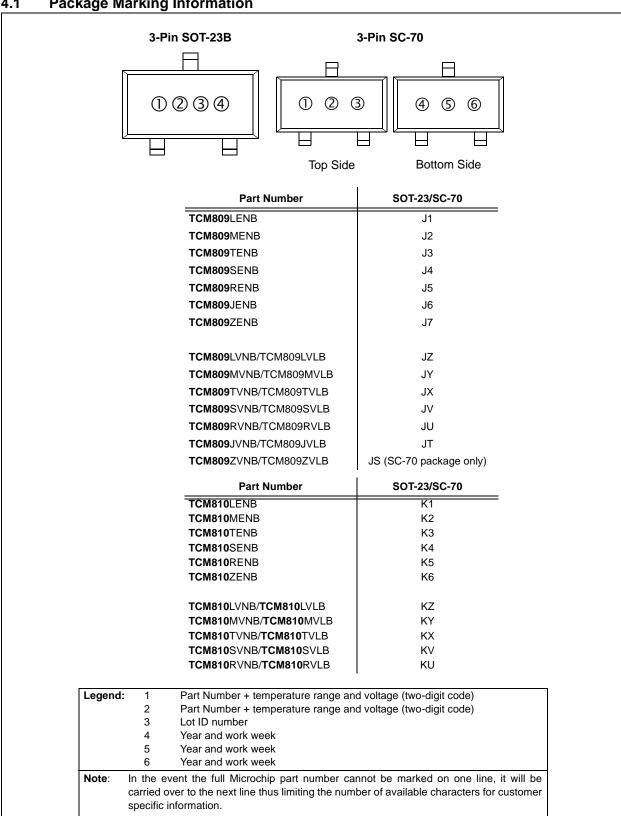
Some microcontrollers have bidirectional reset pins. Depending on the current drive capability of the controller pin, an indeterminate logic level may result if there is a logic conflict. This can be avoided by adding a 4.7 k $\Omega$  resistor in series with the output of the TCM809/TCM810 (Figure 3-3). If there are other components in the system that require a reset signal, they should be buffered so as not to load the reset line. If the other components are required to follow the reset I/O of the microcontroller, the buffer should be connected as shown with the solid line.



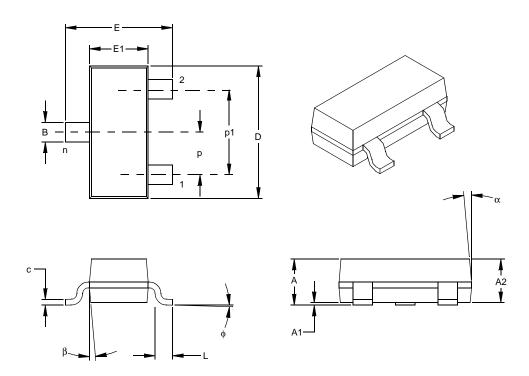
**FIGURE 3-3:** Interfacing the TCM809 to a Bidirectional RESET I/O.

#### 4.0 PACKAGING INFORMATION

#### 4.1 **Package Marking Information**



## 3-Lead Plastic Small Outline Transistor (NB) (SOT-23)



	Units		INCHES*	MILLIMETERS			
Dimensi	on Limits	MIN	NOM	MAX	MIN	NOM	MAX
Number of Pins	n		3			3	
Pitch	р		.038			0.96	
Outside lead pitch (basic)	p1		.076			1.92	
Overall Height	Α	.035	.040	.044	0.89	1.01	1.12
Molded Package Thickness	A2	.035	.037	.040	0.88	0.95	1.02
Standoff §	A1	.000	.002	.004	0.01	0.06	0.10
Overall Width	E	.083	.093	.104	2.10	2.37	2.64
Molded Package Width	E1	.047	.051	.055	1.20	1.30	1.40
Overall Length	D	.110	.115	.120	2.80	2.92	3.04
Foot Length	L	.014	.018	.022	0.35	0.45	0.55
Foot Angle	ф	0	5	10	0	5	10
Lead Thickness	С	.004	.006	.007	0.09	0.14	0.18
Lead Width	В	.015	.017	.020	0.37	0.44	0.51
Mold Draft Angle Top	α	0	5	10	0	5	10
Mold Draft Angle Bottom	β	0	5	10	0	5	10

### Notes:

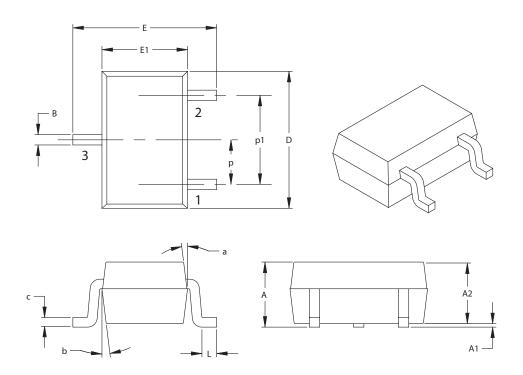
Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed .010" (0.254mm) per side.

JEDEC Equivalent: TO-236

Drawing No. C04-104

<sup>\*</sup> Controlling Parameter § Significant Characteristic

## 3-Lead Plastic Small Outline Transistor (LB) (SC-70)



	Units			MILLIMETERS*	
Dimension Limi	ts	MIN	MAX	MIN	MAX
Number of Pins		3	3	3	3
Pitch	р	.026 BS	ic.	0.65 BSC.	
Outside lead pitch (basic)	p1	.051 BS	C.	1.30 BS	C.
Overall Height	Α	.031	.043	0.80	1.10
Molded Package Thickness	A2	.031	.039	0.80	1.00
Standoff	A1	.000	.0004	0.00	.010
Overall Width	E	.071	.094	1.80	2.40
Molded Package Width	E1	.045	.053	1.15	1.35
Overall Length	D	.071	.089	1.80	2.25
Foot Length	L	.004	.016	0.10	0.41
Lead Thickness	С	.003	.010	0.08	0.25
Lead Width	В	.006	.016	0.15	0.40
Mold Draft Angle Top	a	8°	12°	8°	12°
Mold Draft Angle Bottom	b	8°	12°	8°	12°

<sup>\*</sup>Controlling Parameter

Notes

Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed .005" (0.127mm) per side.

JEITA (EIAJ) Equivalent: SC70 Drawing No. C04-104

## 4.2 Product Tape and Reel Specifications

FIGURE 4-1: EMBOSSED CARRIER DIMENSIONS (8, 12, 16, AND 24 MM TAPE ONLY)

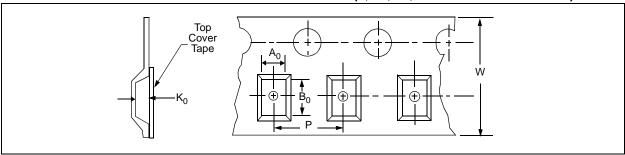
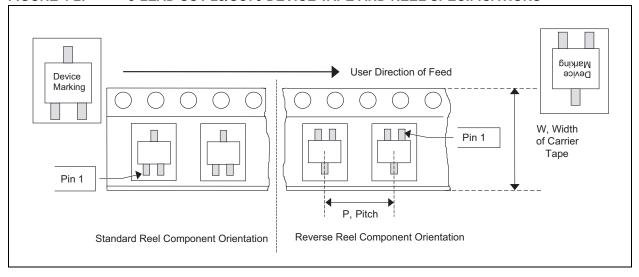


TABLE 1: CARRIER TAPE/CAVITY DIMENSIONS

Case	Package		Carrier Dimensions		Cavity Dimensions			Output	Reel Diameter in
Outline	Outline Type		W mm	P mm	A0 mm	B0 mm	K0 mm	Quantity Units	mm
NB	SOT-23	3L	8	4	3.15	2.77	1.22	3000	180
LB	SC-70	3L	8	4	2.4	2.4	1.19	3000	180

### FIGURE 4-2: 3-LEAD SOT-23/SC70 DEVICE TAPE AND REEL SPECIFICATIONS



### PRODUCT IDENTIFICATION SYSTEM

To order or obtain information, e.g., on pricing or delivery, refer to the factory or the listed sales office.

PART NO.	<u>X</u>	<u>X</u>	XXXXX	Ex	amples:	
	V <sub>DD</sub> Reset reshold	Temperature Range	 Package	a)	TCM809LENB713:	SOT-23B-3-TR, Microcontroller 4.63V Reset Monitor, -40°C to +85°C, Tape and Reel.
Device:			vith active-low RESET output vith active-high RESET outpu		TCM809LVLB713:	SC-70-3-TR, Microcontroller 4.63V Reset Monitor, -40°C to +125°C, Tape and Reel.
V <sub>DD</sub> Reset Threshold:	M = 4 J = 4 T = 3 S = 2 R = 2	I.63V I.38V I.00V I.08V I.93V		с)	TCM809LVNB713:	SOT-23B-3-TR, Microcontroller 4.63V Reset Monitor, -40°C to +125°C, Tape and Reel.
Temperature Range:	E = -	2.32V 40°C to +85°C 40°C to +125°C		a)	TCM810MENB713:	SOT-23B-3-TR, Microcontroller 4.38V Reset Monitor, -40°C to +85°C, Tape and Reel.
Package:		= SOT-23B, 3-pin (Ta = SC-70, 3-pin (Tape		b)	TCM810RVLB713:	SOT-23B-3-TR, Microcontroller 2.63V Reset Monitor, -40°C to +125°C, Tape and Reel.
				c)	TCM810TVLB713:	SC-70-3-TR, Microcontroller 4.38V Reset Monitor, -40°C to +125°C, Tape and Reel.

## **Sales and Support**

### **Data Sheets**

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TCM809/TCM810		
NOTES:		

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